



In re Application of:  
Prabhu, et al.

Serial No.: 10/693,683

Confirmation No.: 8666

Filed: October 24, 2003

For: Polishing Processes for  
Shallow Trench Isolation  
Substrates

Group Art Unit: 3723


Examiner: Jacob K. Ackun

**MAIL STOP AF**  
**Commissioner for Patents**  
**P.O. Box 1450**  
**Alexandria, VA 22313-1450**

**CERTIFICATE OF MAILING**  
**37 CFR 1.8**

I hereby certify that this correspondence is being deposited on October 11, 2005 with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Date October 11, 2005

450.  
  
Keith M. Tackett

Dear Sir:

**RESPONSE TO FINAL OFFICE ACTION DATED AUGUST 12, 2005**

In response to the Final Office Action dated August 12, 2005, having a shortened statutory period for response set to expire on November 12, 2005, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicants believe that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/007985/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 5 of this paper.